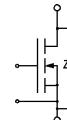


SEMITRANS® M
Power MOSFET Modules
SKM 181**SEMITRANS M1****Features**

- N Channel, enhancement mode
- Short internal connections avoid oscillations
- Switching kW's in less than 1 μ s
- Isolated copper baseplate
- All electrical connections on top for easy busbaring
- Large clearances and creepage distances
- UL recognized, file no. E 63 532

Typical Applications

- Switched mode power supplies
- DC servo and robot drives
- DC choppers
- Resonant and welding inverters
- AC motor drives
- Laser power supplies
- UPS equipment
- Plasma cutting
- Not suitable for linear amplification

This is an electrostatic discharge sensitive device (ESDS). Please observe the international standard IEC 747-1, Chapter IX.

Absolute Maximum Ratings		Values	Units
Symbol	Conditions¹⁾		
V _D S	R _G S = 20 k Ω	800	V
V _{DGR}		800	V
I _D		36	A
I _{DM}		144	A
V _{GS}		± 20	V
P _D		700	W
T _j , T _{stg}		– 55 ... +150	°C
V _{isol}	AC, 1 min	2 500	V
humidity	DIN 40 040	Class F	
climate	DIN IEC 68 T.1	55/150/56	
Inverse Diode			
I _F = – I _D		36	A
I _{FM} = – I _{DM}		144	A
Characteristics		Units	
Symbol	Conditions¹⁾		
V _{(BR)DSS}	V _{GS} = 0, I _D = 0,25 mA	800	V
V _{GS(th)}	V _{GS} = V _D S, I _D = 1 mA	2,1	V
I _{DSS}	V _{GS} = 0, { T _j = 25 °C	–	μ A
	V _D S = 800 V T _j = 125 °C	50	μ A
I _{GS}	V _{GS} = 20 V, V _D S = 0	300	μ A
R _{D(on)}	V _{GS} = 10 V, I _D = 23 A	1000	nA
g _f s	V _{GS} = 25 V, I _D = 23 A	–	m Ω
C _{CHC}		15	S
C _{iss}	V _{GS} = 0	25	
C _{oss}	V _D S = 25 V	32	
C _{rss}	f = 1 MHz	1,3	
L _{Ds}		0,5	
t _{d(on)}	V _{DD} = 400 V	160	pF
t _r	I _D = 23 A	24	nF
t _{d(off)}	V _{GS} = 10 V	32	nF
t _r	R _G S = 3,3 Ω	0,8	nF
		–	nH
Inverse Diode		–	–
V _{SD}	I _F = 72 A, V _{GS} = 0	1,1	V
t _{rr}	T _j = 25 °C ²⁾	1200	ns
	T _j = 150 °C ²⁾	–	ns
Q _{rr}	T _j = 25 °C ²⁾	42	μ C
	T _j = 150 °C ²⁾	50	μ C
Thermal Characteristics		°C/W	
R _{thjc}		0,18	
R _{thch}	M ₁ , surface 10 μ m	0,05	

Mechanical Data			
M ₁	to heatsink, SI Units	4	–
	to heatsink, US Units	35	5
M ₂	for terminals, SI Units	–	Nm
	for terminals, US Units	2,5	lb.in.
a		22	Nm
w		–	lb.in.
		5x9,81	m/s ²
Case	→ page B 5 – 2	150	g
		D 15	

¹⁾ T_{case} = 25 °C, unless otherwise specified.²⁾ I_F = – I_D, V_R = 100 V, – di_F/dt = 100 A/ μ s

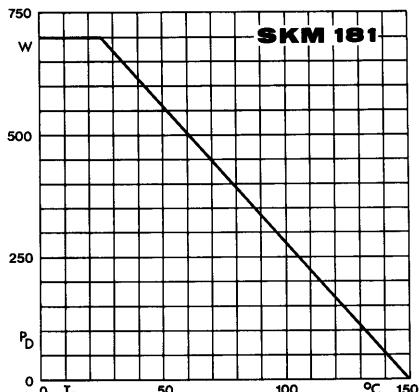


Fig. 1 Rated power dissipation vs. temperature

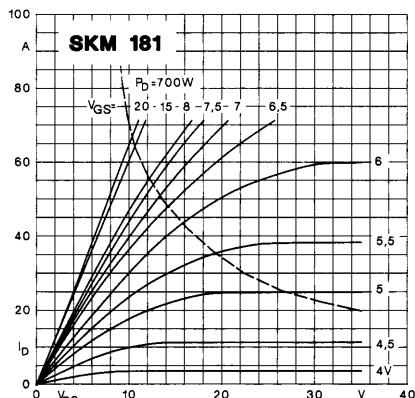


Fig. 3 Output characteristic

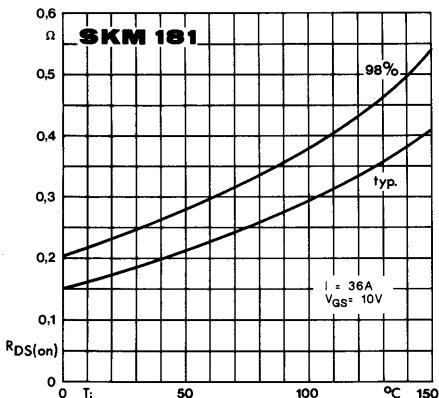


Fig. 5 On-resistance vs. temperature

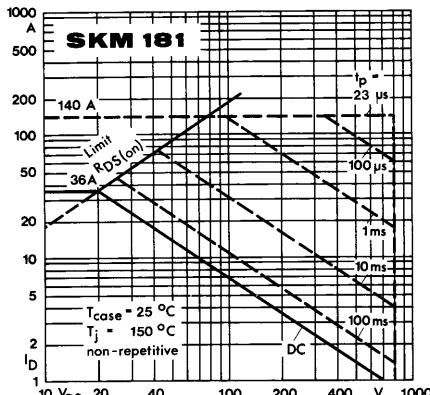


Fig. 2 Maximum safe operating area

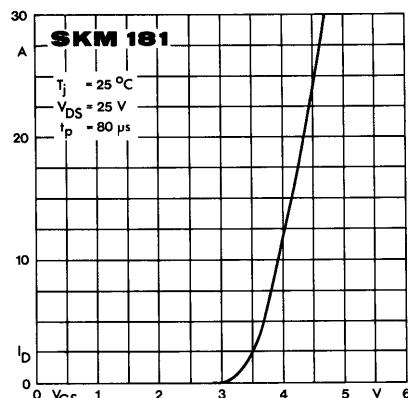


Fig. 4 Transfer characteristic

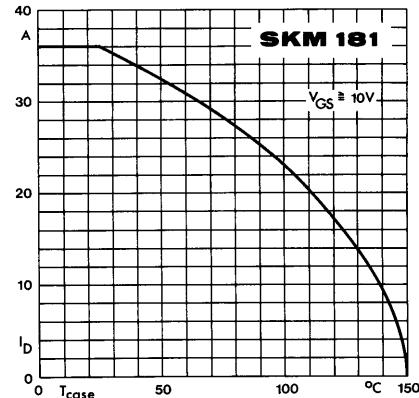


Fig. 6 Rated current vs. temperature

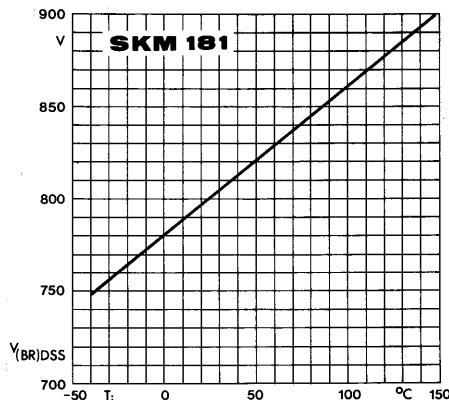


Fig. 7 Breakdown voltage vs. temperature

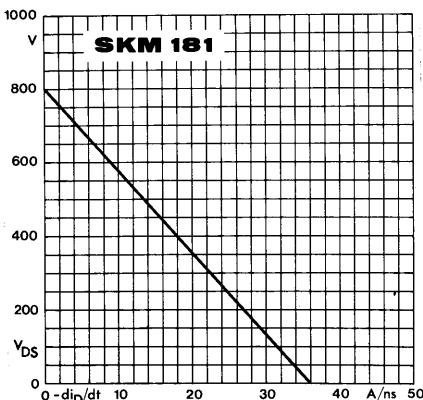


Fig. 8 Drain-source voltage derating

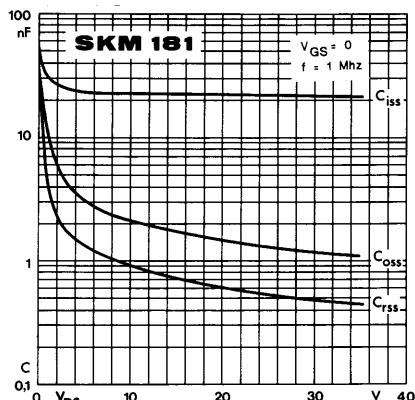


Fig. 9 Capacitances vs. drain-source voltage

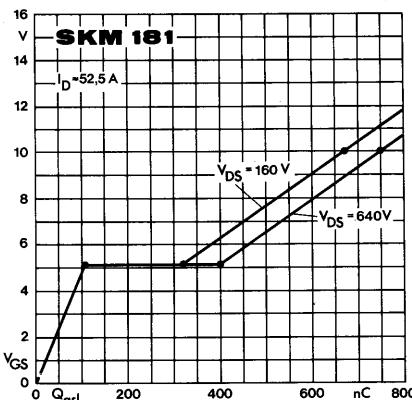


Fig. 10 Gate charge characteristic

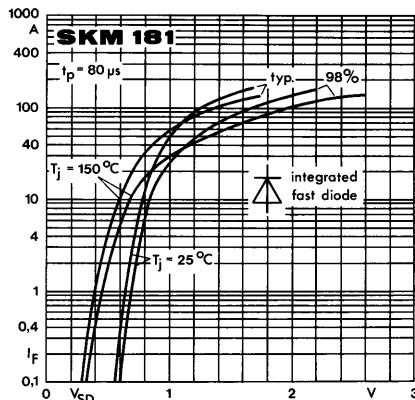


Fig. 11. Diode forward characteristic

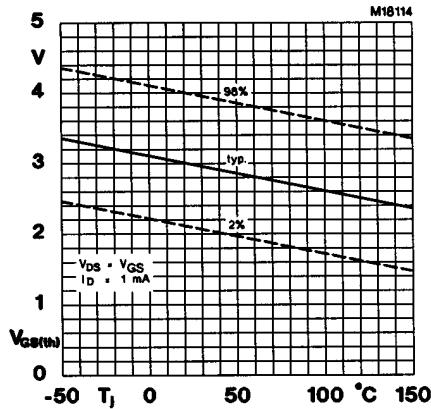


Fig. 14 Gate-source threshold voltage

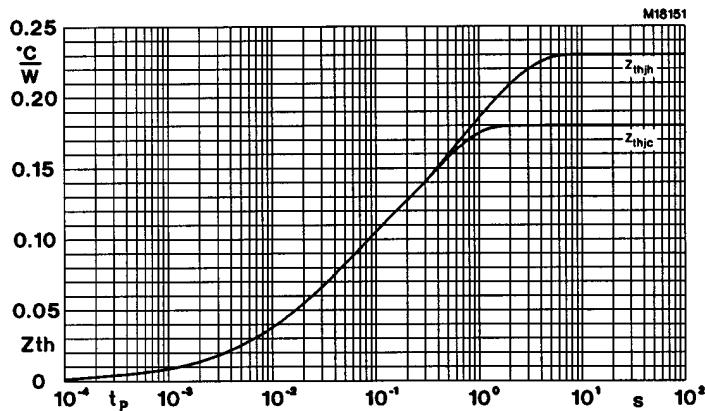


Fig. 51 Transient thermal impedance

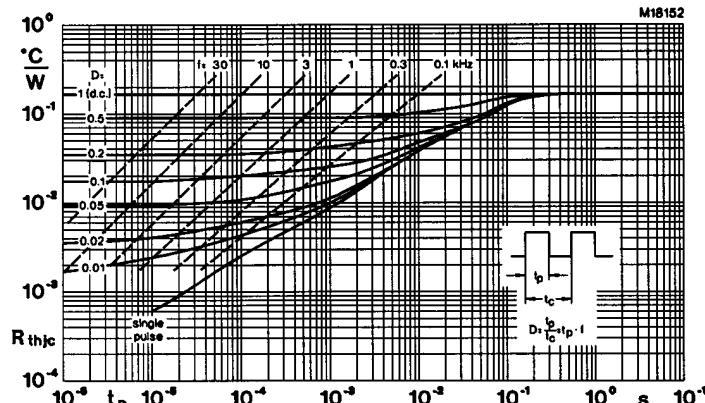


Fig. 52 Thermal impedance under pulse conditions